

DELL XPS 9640 Intel Core Ultra 9 185H Computer portatile 41,4 cm (16.3") Touch screen UHD+ 32 GB LPDDR5x-SDRAM 1 TB SSD NVIDIA GeForce RTX 4060 Wi-Fi 7 (802.11be) Windows 11 Pro **Italiano** Platino

Marchio : DELL

Famiglia del prodotto: XPS

Codice prodotto: V35PK

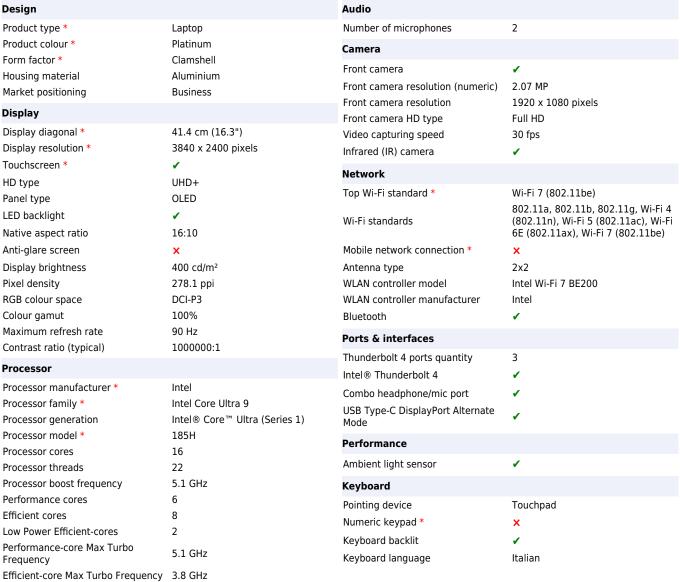
Nome del prodotto : 9640

- Windows 11 Pro 64-bit
- Intel Core Ultra 9 185H (24MB Cache)
- 41.4 cm (16.3") UHD+ 3840 x 2400 OLED Touch, NVIDIA GeForce RTX 4060 (8GB GDDR6)
- 32GB LPDDR5x-SDRAM & 1000GB SSD

Intel Core Ultra 9 185H (24MB Cache), 32GB LPDDR5x-SDRAM, 1000GB SSD, 41.4 cm (16.3") UHD+ 3840 x 2400 OLED Touch, Intel Arc Graphics, NVIDIA GeForce RTX 4060 (8GB GDDR6), WLAN, Webcam, Windows 11 Pro 64-bit

DELL XPS 9640 Intel Core Ultra 9 185H Computer portatile 41,4 cm (16.3") Touch screen UHD+ 32 GB LPDDR5x-SDRAM 1 TB SSD NVIDIA GeForce RTX 4060 Wi-Fi 7 (802.11be) Windows 11 Pro Italiano Platino:

Alimenta le tue passioni con notebook premium realizzati con precisione artigianale e dotati di funzionalità innovative.







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Carbon emissions, end-of-life (kg of 2	Built-in microphone	1		46
				2

Carbon footprint	
Total carbon emissions, w/o use phase (kg of CO2e)	318
PAIA version	1.4.0
Packaging content	
Stylus pen	×
Cables included	AC



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